

Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Maximum Rating condition for extended periods may affect device reliability and lifetime.

Supply Voltage.....+4.2V

Input Voltage.....-0.5V to VCC + 0.5V

Output Voltage.....-0.5V to VCC + 0.5V

Reference Frequency/Input Crystal.....10MHz to 60MHz

Storage Temperature.....-55°C to +125°C

Lead Temperature (Soldering, 10 sec).....300°C

ESD Rating (HBM - Human Body Model).....2kV

Operating Conditions

Operating Temperature Range.....-40°C to +85°C

Electrical Characteristics

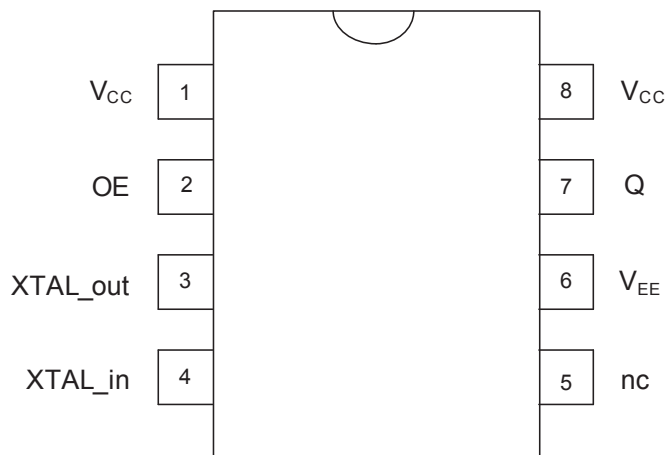
Unless otherwise noted: $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 3.3\text{V} \pm 5\%$ or $2.5\text{V} \pm 5\%$, $V_{EE} = 0\text{V}$

Symbol	Parameter	Conditions	*	Min	Typ	Max	Units
3.3V Power Supply DC Characteristics							
V_{CC}	Power Supply Voltage		•	3.135	3.3	3.465	V
I_{EE}	Power Supply Current	125MHz with output unloaded.			24		mA
2.5V Power Supply DC Characteristics							
V_{CC}	Power Supply Voltage		•	2.375	2.5	2.625	V
I_{EE}	Power Supply Current	125MHz with the output unloaded.			21		mA
LVCMOS/LVTTL DC Characteristics							

Symbol	Parameter	Conditions	*	Min	Typ	Max	Units
V_{IH}	Input High Voltage	$V_{CC} = 3.465\text{V}$	•	2.42		$V_{CC} + 0.3$	V
		$V_{CC} = 2.625\text{V}$	•	1.83		$V_{CC} + 0.3$	V
V_{IL}	Input Low Voltage	$V_{CC} = 3.465\text{V}$	•	-0.3		1.03	V
		$V_{CC} = 2.625\text{V}$	•	-0.3		0.785	V
I_{IH}	Input High Current (OE, FSEL[1:0])	$V_{IN} = V_{CC} = 3.465\text{V}$ or 2.625V	•			15	μA
I_{IL}	Input Low Current (OE, FSEL[1:0])	$V_{IN} = 0\text{V}$, $V_{CC} = 3.465\text{V}$ or 2.625V	•	-10			μA
LVCMOS DC Characteristics							
V_{OH}	Output High Voltage	Output unloaded	•	$0.8 \times V_{CC}$			V
V_{OL}	Output Low Voltage	Output unloaded	•			$0.1 \times V_{CC}$	V
Crystal Characteristics							
X_{Mode}	Mode of Oscillations			Fundamental			
X_f	Frequency				25		MHz
ESR	Equivalent Series Resistance					50	Ω
C_S	Shunt Capacitance					7	pF
AC Characteristics							
f_{OUT}	Output Frequency				125		MHz
$t_{jit}(\phi)$	RMS Phase Jitter	125MHz (Int. Range 1.875MHz-20MHz)			0.15		pS
$t_{jit}(cc)$	Cycle-to-Cycle Jitter	Using 25MHz, 18pF resonant crystal	•			10	pS
t_R/t_F	Output Rise/Fall Time	20% to 80%	•	100		550	pS
Odc	Output Duty Cycle		•	48		52	%

* Limits applying over the full operating temperature range are denoted by a “•”

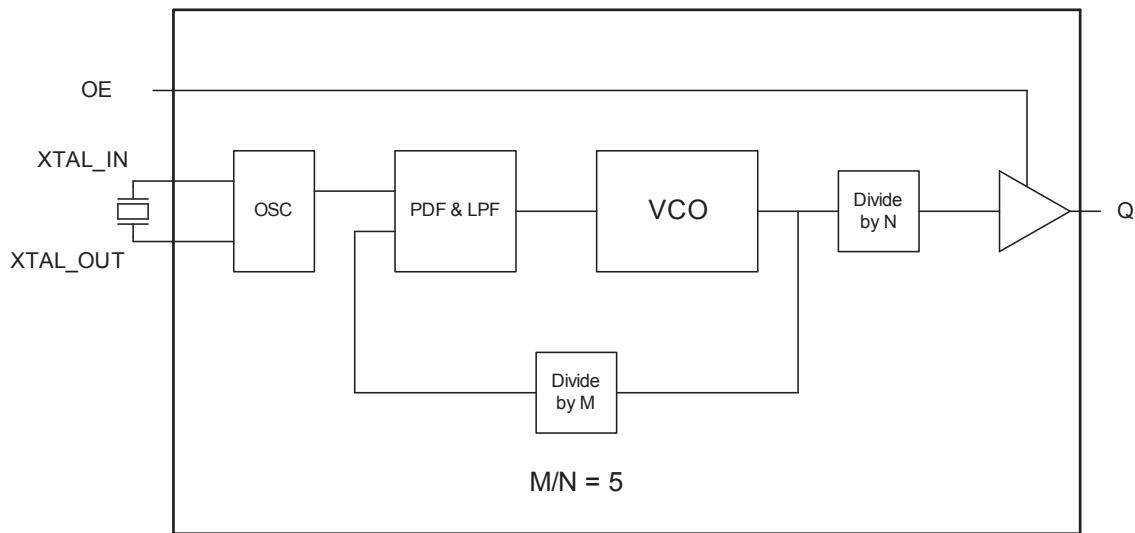
Pin Configuration



Pin Assignments

Pin No.	Pin Name	Type	Description
1	V _{CC}	Supply	Power supply pin.
2	OE	Input (900K Ω pull-up)	Output enable pin - LVCMOS/LVTTL active high input. Outputs are enabled when OE = high. Outputs are disabled when OE = low.
3	XTAL_OUT	Output	Crystal oscillator output.
4	XTAL_IN	Input	Crystal oscillator input.
5	nc	No Connect	Unused, do not connect.
6	V _{EE}	Supply	Negative supply pin.
7	Q	Output	LVCMOS output.
8	V _{CC}	Supply	Power supply pin.

Functional Block Diagram



Typical Performance Characteristics

Figure 1 shows a typical phase noise performance plots for a 125MHz clock output. The data was taken using the industry standard Agilent E5052B phase noise instrument. The integration range is 1.875MHz to 20MHz.

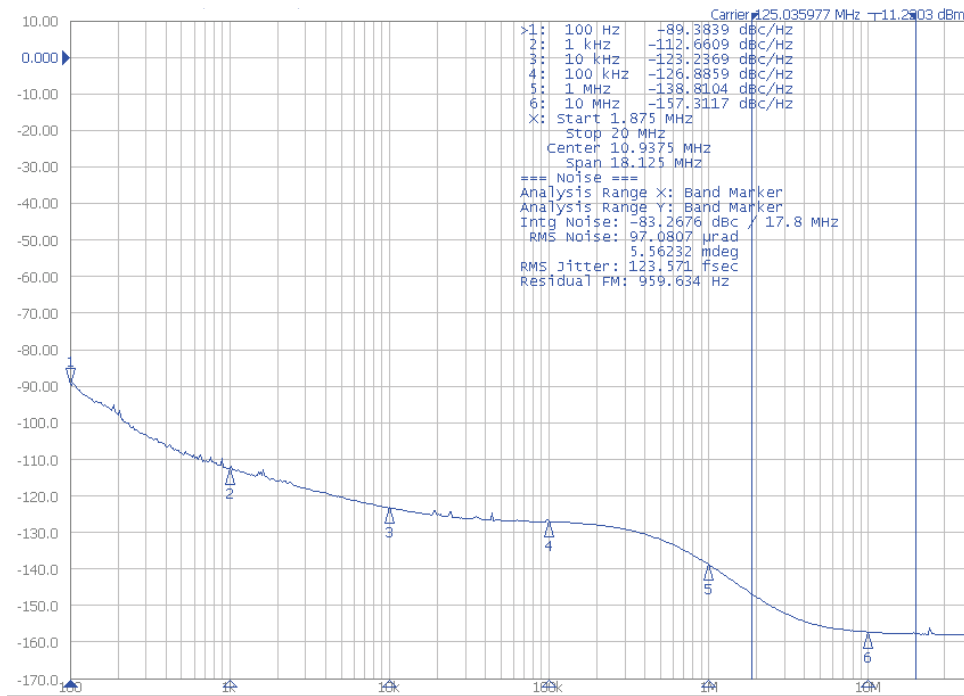


Figure 1: 125MHz Operation, Typical Phase Noise at 3.3V

Application Information

Termination for LVCMOS Outputs

The termination schemes shown in Figure 2 and Figure 3 are typical for LVCMOS outputs. A split supply approach can be used utilizing the scope's internal 50Ω impedance, as shown in Figure 4.

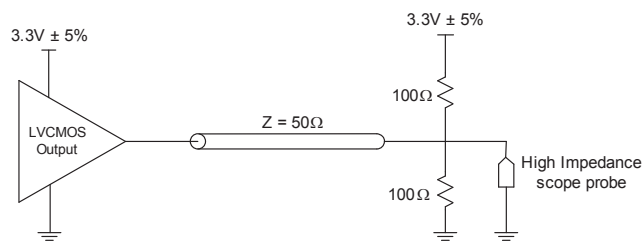


Figure 2: XR81101 3.3V LVCMOS Output Termination

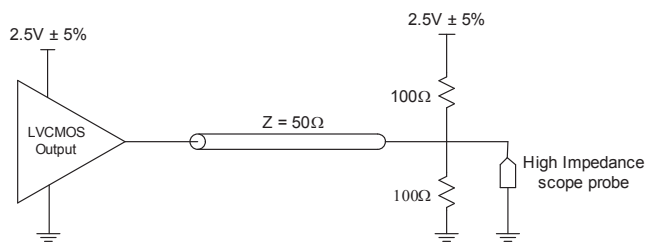


Figure 3: XR81101 2.5V LVCMOS Output Termination

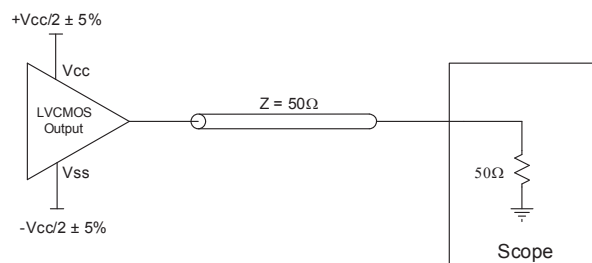


Figure 4: XR81101 Split Supply LVCMOS Output Termination

Output Signal Timing Definitions

The following diagrams clarify the common definitions of the AC timing measurements.

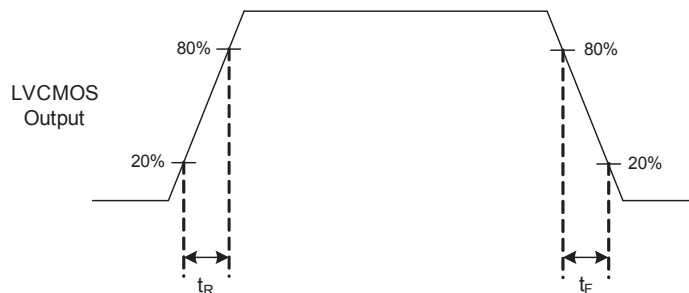
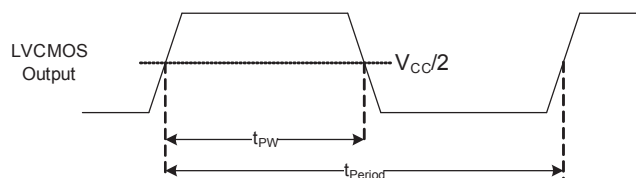


Figure 5: Cycle-to-Cycle Jitter

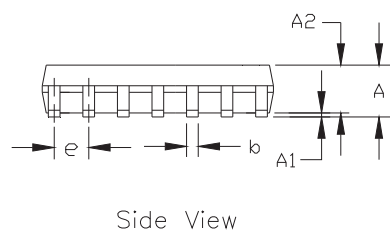
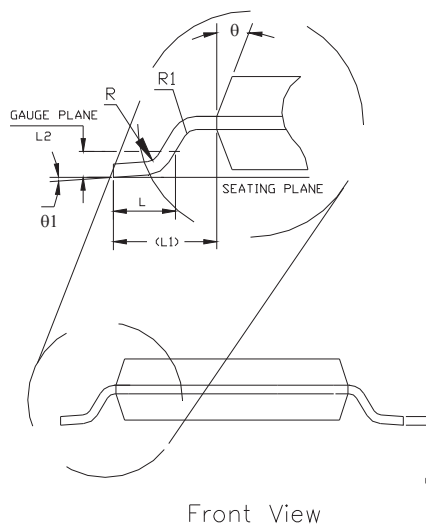
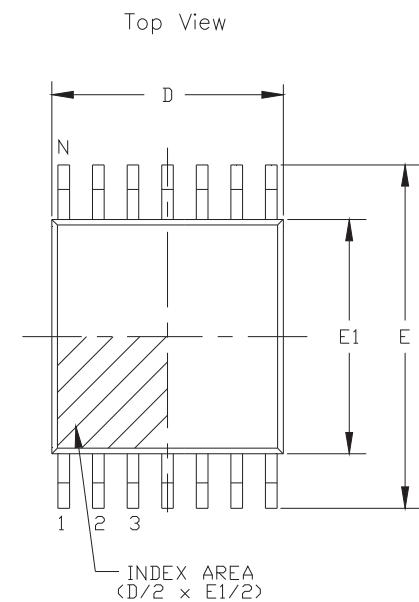


$$\text{Odc} = \frac{t_{PW}}{t_{Period}} \times 100\%$$

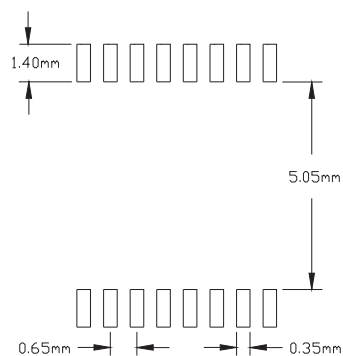
Figure 6: Output Rise/Fall Time

Mechanical Dimensions

8-Pin TSSOP



RECOMMENDED PCB LAND PATTERN



8-Pin TSSOP JEDEC MO-153 Variation AA						
SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.10	—	—	0.043
A1	0.05	—	0.15	0.002	—	0.006
A2	0.85	0.90	0.95	0.033	0.035	0.037
b	0.19	—	0.30	0.007	—	0.012
c	0.09	—	0.20	0.004	—	0.008
E	6.40 BSC			0.252 BSC		
E1	4.30	4.40	4.50	0.169	0.173	0.177
e	0.65 BSC			0.026 BSC		
L	0.50	0.60	0.75	0.020	0.024	0.030
L1	1.00 REF			0.039 REF		
L2	0.25 BSC			0.010 BSC		
R	0.09	—	—	0.035	—	—
R1	0.09	—	—	0.035	—	—
θ	12° REF			12° REF		
θ1	0°	—	8°	0°	—	8°
D	2.90	3.00	3.10	0.114	0.118	0.122
N	8			8		

Note: The side, top and landing pattern drawings are general to TSSOP packaging but the table is specific to the 8pin TSSOP.

Ordering Information

Part Number	Package	Green	Operating Temperature Range	Shipping Packaging	Marking
XR81101-AA02-F	8-pin TSSOP	Yes	-40°C to +85°C	Tube	T01
XR81101-AA02TR-F	8-pin TSSOP	Yes	-40°C to +85°C	Tape & Reel	T01
XR81101EVB	Eval Board	N/A	N/A	N/A	N/A

Revision History

Revision	Date	Description
1A	April 2014	Initial release. [ECN1416-07 04/18/2014]

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